



DYNATRON

The Thermal Solution Architect

WWW.DYNATRON-CORP.COM

Product Spec Sheet

B8

Application :

- Recommend for Intel® Xeon® Platinum / Gold Family Processor (Products formerly Skylake), Socket FCLGA3647
- **For Narrow ILM Only**
- Passive Cooler for 2U Server and up

Overall Specification :

- Dimension: 108 x 80 x 64 mm
- Weight: 600 g
- Material : Copper1100 Base, Aluminum Stacked Fin wit Heatpipe Embedded
- Convenient Heat Sink Screw captive mounting
- Thermal Grease Shin-Etsu 7762 Pre-printed
- Support CPU power up to 205 Watts heat dissipation
- Includes both Fabric and Non-Fabric Package Carriers

Passive Cooler B8 Thermal Performance Curve :

